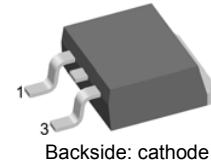
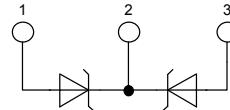


## Schottky Diode

High Performance Schottky Diode  
Low Loss and Soft Recovery  
Common Cathode

Part number

DSSK18-0025BS



### Features / Advantages:

- Very low V<sub>f</sub>
- Extremely low switching losses
- low I<sub>rm</sub> values
- Improved thermal behaviour
- High reliability circuit operation
- Low voltage peaks for reduced protection circuits
- Low noise switching

### Applications:

- Rectifiers in switch mode power supplies (SMPS)
- Free wheeling diode in low voltage converters

### Package:

- Housing: TO-263 (D2Pak)
- Industry standard outline
- Epoxy meets UL 94V-0
- RoHS compliant

### Ratings

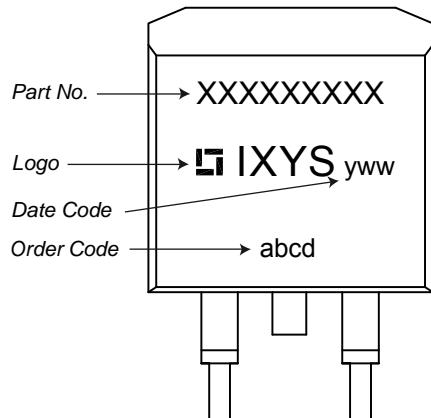
Symbol	Definition	Conditions	min.	typ.	max.	Unit
V <sub>RRM</sub>	max. repetitive reverse voltage	T <sub>vJ</sub> = 25°C			25	V
I <sub>R</sub>	reverse current	V <sub>R</sub> = 25V			10	mA
		V <sub>R</sub> = 25V			40	mA
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 10A	T <sub>vJ</sub> = 25°C		0.45	V
		I <sub>F</sub> = 20A			0.56	V
		I <sub>F</sub> = 10A	T <sub>vJ</sub> = 125°C		0.37	V
		I <sub>F</sub> = 20A			0.51	V
I <sub>FAV</sub>	average forward current	rectangular, d = 0.5	T <sub>C</sub> = 140°C		10	A
V <sub>F0</sub>	threshold voltage	slope resistance } for power loss calculation only			0.20	V
				14.6	mΩ	
R <sub>thJC</sub>	thermal resistance junction to case				1.70	K/W
T <sub>vJ</sub>	virtual junction temperature		-55		150	°C
P <sub>tot</sub>	total power dissipation		T <sub>C</sub> = 25°C		75	W
I <sub>FSM</sub>	max. forward surge current	t = 10 ms (50 Hz), sine			140	A
C <sub>J</sub>	junction capacitance	V <sub>R</sub> = tbd V; f = 1 MHz	T <sub>vJ</sub> = 25°C	tbd		pF

Symbol	Definition	Conditions	Ratings		
			min.	typ.	max.
$I_{RMS}$	RMS current	per pin <sup>1)</sup>			35 A
$R_{thCH}$	thermal resistance case to heatsink			0.25	K/W
$T_{stg}$	storage temperature		-55		150 °C
<b>Weight</b>				2	g
$F_c$	mounting force with clip		20		60 N

<sup>1)</sup>  $I_{RMS}$  is typically limited by: 1. pin-to-chip resistance; or by 2. current capability of the chip.

In case of 1, a common cathode/anode configuration and a non-isolated backside, the whole current capability can be used by connecting the backside.

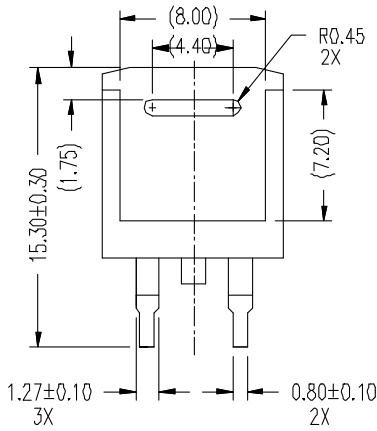
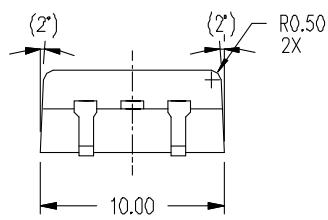
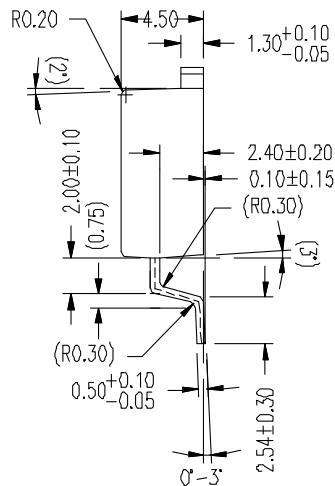
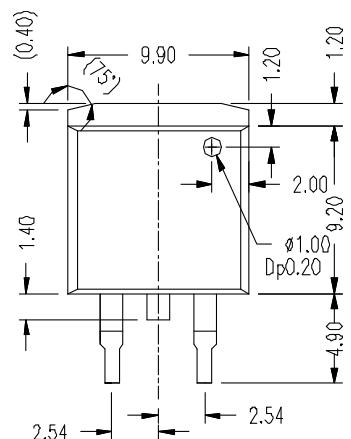
## Product Marking



Ordering	Part Name	Marking on Product	Delivering Mode	Base Qty	Code Key
Standard	DSSK18-0025BS	DSSK18-0025BS	Tape and Reel	800	499099

Similar Part	Package	Voltage class
DSB30C30PB	TO-220	30

## Outlines TO-263 (D2Pak)



## NOTE:

1. These dimensions do not include mold protrusion.
2. ( ) is reference dimension only.